# SN5433, SN54LS33, SN7433, SN74LS33 QUADRUPLE 2 INPUT POSITIVE NOR BUFFERS WITH OPEN-COLLECTOR OUTPUTS

**SDLS101** 

DECEMBER 1983-REVISED MARCH 1988

- Package Options Include Plastic "Small Outline" Packages, Ceramic Chip Carriers and Flat Packages, and Plastic and Ceramic DIPs
- Dependable Texas Instruments Quality and Reliability

## description

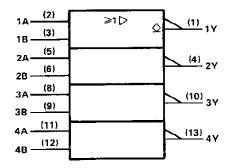
These devices contain four independent 2-input NOR buffer gates with open-collector outputs. Open-collector outputs require resistive pull-up to perform logically but can deliver higher VOH levels and are commonly used in wired-AND applications.

The SN5433 and SN54LS33 are characterized for operation over the full military temperature range of  $-55\,^{\circ}\text{C}$  to 125 $\,^{\circ}\text{C}$ . The SN7433, and SN74LS33 are characterized for operation from 0 $\,^{\circ}\text{C}$  to 70 $\,^{\circ}\text{C}$ .

#### **FUNCTION TABLE (each gate)**

INP	UTS	OUTPUT
Α	В	Y
Н	Х	L
×	н	Ŀ
L	L	н

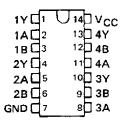
## logic symbol†



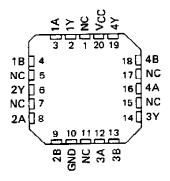
 $<sup>^\</sup>dagger$  This symbol is in accordance with ANSI/IEEE Std 91-1984 and IEC Publication 617-12.

Pin numbers shown are for D, J, N, and W packages.

SN5433, SN54LS33...J OR W PACKAGE SN7433...N PACKAGE SN74LS33...D OR N PACKAGE (TOP VIEW)

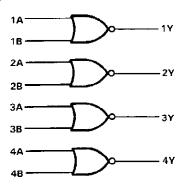


SN54LS33 . . . FK PACKAGE (TOP VIEW)



NC - No internal connection

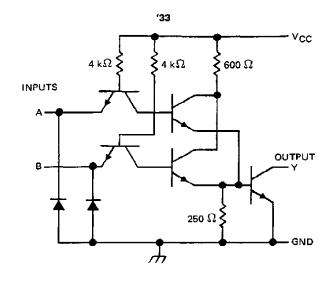
#### logic diagram

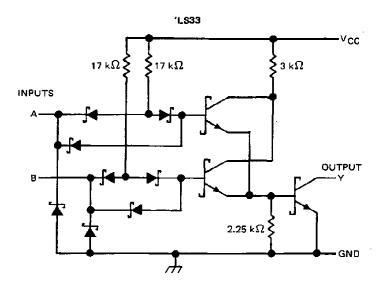


#### positive logic

 $Y = \overline{A + B}$  or  $Y = \overline{A \cdot B}$ 

schematics (each gate)





Resistor values shown are nominal.

absolute maximum ratings over operating free-air temperature range (unless otherwise noted)

	Supply voltage, VCC (see Note 1)
	Input voltage: '33
	′LS33
	Off-state output voltage
	Operating free-air temperature: SN54'
	SN74'
	Storage temperature range $\dots -65^{\circ}C$ to $150^{\circ}C$
NOTE 1	I: Voltage values are with respect to network ground terminal.

## SN5433, SN7433 QUADRUPLE 2-INPUT POSITIVE-NOR BUFFERS WITH OPEN-COLLECTOR OUTPUTS

#### recommended operating conditions

		SN5433				UNIT		
		MIN	NOM	MAX	MIN	NOM	MAX	ONL
Vcc	Supply voltage	4.5	5	5.5	4.75	5	5.25	V
VIH	High-level input voltage	2			2			٧
VIL	Low-level input voltage			0.8			0.8	٧
Voн	High-level output voltage			5.5			5.5	
loL	Low-level output current			48			48	mA
TA	Operating free-air temperature	- 55		125	0		70	°C

## electrical characteristics over recommended operating free-air temperature range (unless otherwise noted)

7494145779	TEST CONDITIONS†	SN5433	-	SN7433	3	UNIT	
PARAMETER	TEST CONDITIONS	MIN TYP‡	MAX	MIN	TYP‡	MAX	UNII
VIK	V <sub>CC</sub> = MIN, I <sub>I</sub> = -12 mA		-1.5			- 1.5	v
	$V_{CC} = MIN, V_{IL} = 0.8 \text{ V}, V_{OH} = 5.5 \text{ V}$					0.25	mA
юн	$V_{CC} = MIN, V_{IL} = 0.7 \text{ V}, V_{OH} = 5.5 \text{ V}$		0.25				nia.
VOL	V <sub>CC</sub> = MIN. V <sub>IH</sub> = 2 V, I <sub>OL</sub> = 16 mA	0.2	0.4		0.2	0.4	· V
tı	V <sub>CC</sub> = MAX, V <sub>I</sub> = 5.5 V		. 1		·	1	mΑ
lн	$V_{CC} = MAX$ , $V_1 = 2.4 V$		40			40	μА
l)L	$V_{CC} = MAX$ , $V_1 = 0.4 V$		-1.6			- 1.6	mA
ІССН	VCC = MAX, VI = 0	3	6		3	6	mA
ICCL	V <sub>CC</sub> = MAX, See Note 2	9	16.5		9	16.5	mA

<sup>†</sup>For conditions shown as MIN or MAX, use the appropriate value specified under recommended operating conditions.

## switching characteristics, $V_{CC} = 5 \text{ V}$ , $T_A = 25 \,^{\circ}\text{C}$ (see Figure 1)

PARAMETER	FROM (INPUT)	TO (OUTPUT)	TEST CONDITIONS	MIN	TYP	MAX	UNIT
tPLH	<del></del>		$R_{l} = 133 \text{ k}\Omega,  C_{l} = 50 \text{ pF}$		10	15	ns
†PHL	A or B		n[ = 133 ktt, C[ = 50 pr		12	18	ns
tPLH	AUID	'	D 122 LO C 150 mF		15	22	ns
<sup>t</sup> PHL			$R_L = 133 \text{ k}\Omega$ , $C_L = 150 \text{ pF}$		16	24	ns

NOTE 3: Load circuits and voltage waveforms are shown in Section 1.

 $<sup>^{\</sup>ddagger}$ All typical values are at V<sub>CC</sub> = 5 V, T<sub>A</sub> = 25 °C. NOTE 2: One input at 4.5 V, all others at 0 V.

## SN54LS33, SN74LS33 QUADRUPLE 2-INPUT POSITIVE-NOR BUFFERS WITH OPEN-COLLECTOR OUTPUTS

#### recommended operating conditions

	S	SN54L\$33			SN74LS33			
	MIN	NOM	MAX	MIN	NOM	MAX	UNIT	
V <sub>CC</sub> Supply voltage	4.5	5	5.5	4.75	5	5.25	V	
V <sub>IH</sub> High-level input voltage	2			2			V	
V <sub>IL</sub> Low-level input voltage			0,7			8.0	V	
VOH High-level output voltage			5.5			5.5	V	
IOL Low-level output current			12			24	mΑ	
TA Operating free-air temperature	- 55		125	0		70	°C	

## electrical characteristics over recommended operating free-air temperature range (unless otherwise noted)

PARAMETER	TEST CONDITIONS †				SN54LS33			SN74LS33		
PARAMETER		MIN	TYP‡	MAX	MIN	TYP ‡	MAX	UNIT		
VIK	V <sub>CC</sub> = MIN,	l <sub>†</sub> = − 18 mA				- 1.5			- 1.5	V
IOH	VCC = MIN,	V <sub>IH</sub> = 2 V,	VIL = MAX, VOH = 5.5 V			0.25	-		0.25	mΑ
V.	$V_{CC} = MIN$	V <sub>IH</sub> = 2 V,	V <sub>IL</sub> = MAX, I <sub>OL</sub> = 12 mA		0.25	0.4		0.25	0.4	
۷٥٢	V <sub>CC</sub> = MIN,	VIL = MAX,	I <sub>OL</sub> = 24 mA					0.35	0.5	٧
ΙΙ	VCC = MAX,	V <sub>1</sub> = 7 V				0.1			0.1	mΑ
Ιн	V <sub>CC</sub> = MAX,	V <sub>1</sub> = 2.7 V	_			20			20	μА
IL	V <sub>CC</sub> = MAX,	V1 = 0.4 V				<b>- 0,4</b>			- 0.4	mΑ
Іссн	V <sub>CC</sub> = MAX.	V <sub>1</sub> = 0			1.8	3.6		1.8	3.6	mA
ICCL	VCC = MAX,	See Note 2			6.9	13.8		6.9	13.8	mA

<sup>†</sup>For conditions shown as MIN or MAX, use the appropriate value specified under recommended operating conditions.

## switching characteristics, VCC = 5 V, TA = 25°C (see note 3)

PARAMETER	FROM (INPUT)	TO (OUTPUT)	TEST CONDITIONS	MIN	TYP	MAX	UNIT
<sup>t</sup> PLH	A or B	Y	$R_1 \approx 667  \Omega$ , $C_L = 45  pF$	L	20	32	ns
t₽HL	N 51 D	`		1	18	28	ns

NOTE 3: Load circuits and voltage waveforms are shown in Section 1.

 $<sup>^{\</sup>ddagger}$  All typical values are at V<sub>CC</sub> = 5 V, T<sub>A</sub> = 25 °C. NOTE 2: One input at 4.5 V, all others at 0 V.

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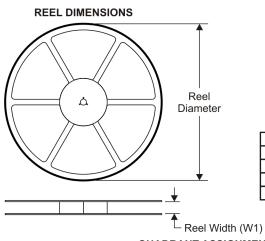
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## TAPE AND REEL INFORMATION





A0	Dimension designed to accommodate the component width
B0	Dimension designed to accommodate the component length
	Dimension designed to accommodate the component thickness
W	Overall width of the carrier tape
P1	Pitch between successive cavity centers

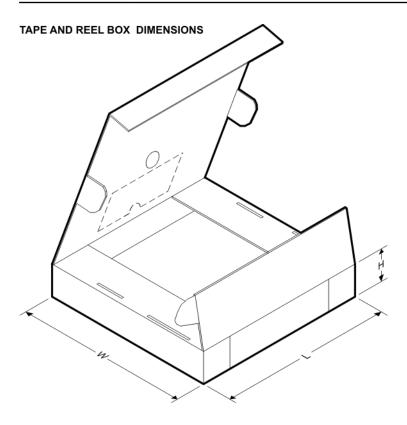
QUADRANT ASSIGNMENTS FOR PIN 1 ORIENTATION IN TAPE



## \*All dimensions are nominal

Device	Package Type	Package Drawing			Reel Diameter (mm)	Reel Width W1 (mm)	A0 (mm)	B0 (mm)	K0 (mm)	P1 (mm)	W (mm)	Pin1 Quadrant
SN74LS33DR	SOIC	D	14	2500	330.0	16.4	6.5	9.0	2.1	8.0	16.0	Q1
SN74LS33NSR	SO	NS	14	2000	330.0	16.4	8.2	10.5	2.5	12.0	16.0	Q1





#### \*All dimensions are nominal

Device	Package Type	Package Drawing	Pins	SPQ	Length (mm)	Width (mm)	Height (mm)
SN74LS33DR	SOIC	D	14	2500	346.0	346.0	33.0
SN74LS33NSR	SO	NS	14	2000	346.0	346.0	33.0

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